

產品承認書

Product Approval Sheet

一.基本內容(INFORMATION)

客戶名稱(Customer Name) :

產品型號(Product Number) : BL-7020C10

料號信息(PN Information) :

客戶料號	參數要求				
	亮度 (mcd)	Φ V(lm)	x/y	電壓 (V)	CRI (Ra)
	Min: 25000	Min: 50	x:0.28;y0.26	Min: 2.9	-

二.供應商確認欄(SUPPLIER)

核准(Approved/Date)	審核(Check/Date)	製作(Prepared/Date)
張孝巖 2016-1-13	張喜光 2016-1-13	熊燦芬 2016-1-13

三.客戶批准欄(CUSTOMER)

產品承認書批准處理：同意 拒絕 其它_____

核准(Approved/Date)	審核(Check/Date)	研發/工程(R&D Dept/Date)

說明：請將已簽副本回覆我司

Please return to us one copy "PRODUCT ACKNOWLEDGEMENT SHEET" with your approved signatures!

佰鴻工業股份有限公司

BRIGHT LED ELECTRONICS CORP.

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Tel: 886-2-29591090

Fax: 886-2-29547006/29558809

www.brtled.com

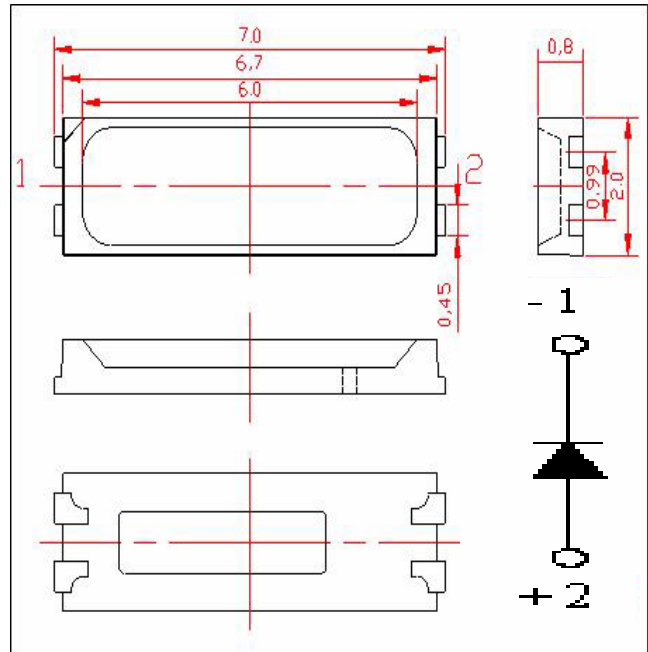
● Features:

1. Emitted Color: White.
2. Lens Appearance: Yellow clear.
3. 7.0x2.0x0.8mm standard package.
4. Suitable for all SMT assembly methods.
5. Compatible with infrared and vapor phase reflow solder process.
6. Compatible with automatic placement equipment.
7. This product doesn't contain restriction Substance, comply ROHS standard.

● Applications:

1. Lighting
2. Automotive lighting.
3. Backlighting: LCDs
4. Status indicators: Consumer & industrial electronics.
5. General use.

● Package Dimensions:



Notes:

1. All dimensions are in millimeters.
2. Tolerance is ± 0.2 mm unless otherwise specified.
3. Specifications are subject to change without notice.

● Absolute Maximum Ratings(Ta=25°C)

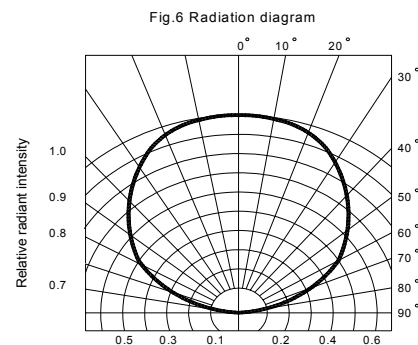
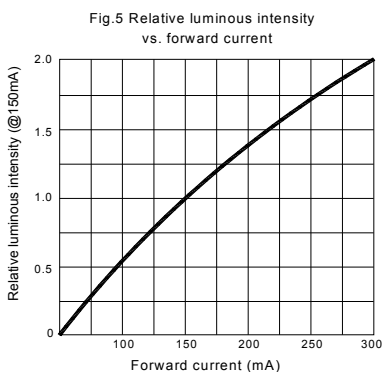
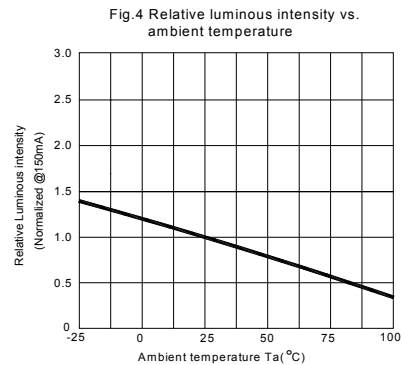
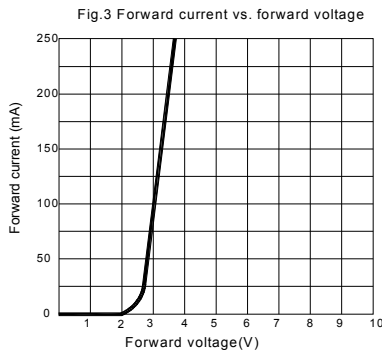
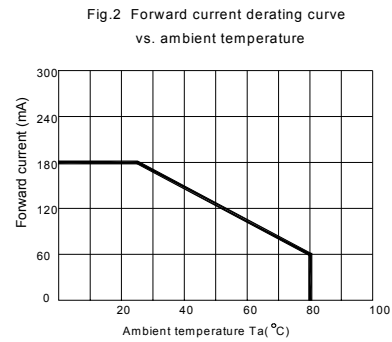
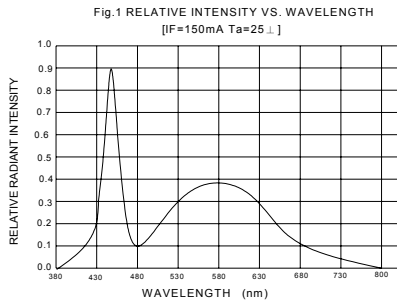
Parameter	Symbol	Rating	Unit
Power Dissipation	P_D	500	mW
Forward Current	I_F	180	mA
Peak Forward Current*1	I_{FP}	270	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-40°C~85°C	-
Storage Temperature	T_{stg}	-40°C~85°C	-
Soldering Temperature	T_{sol}	See Page 9	-

Note : I_{FP} is pulse of 1/10 duty at 1KHz

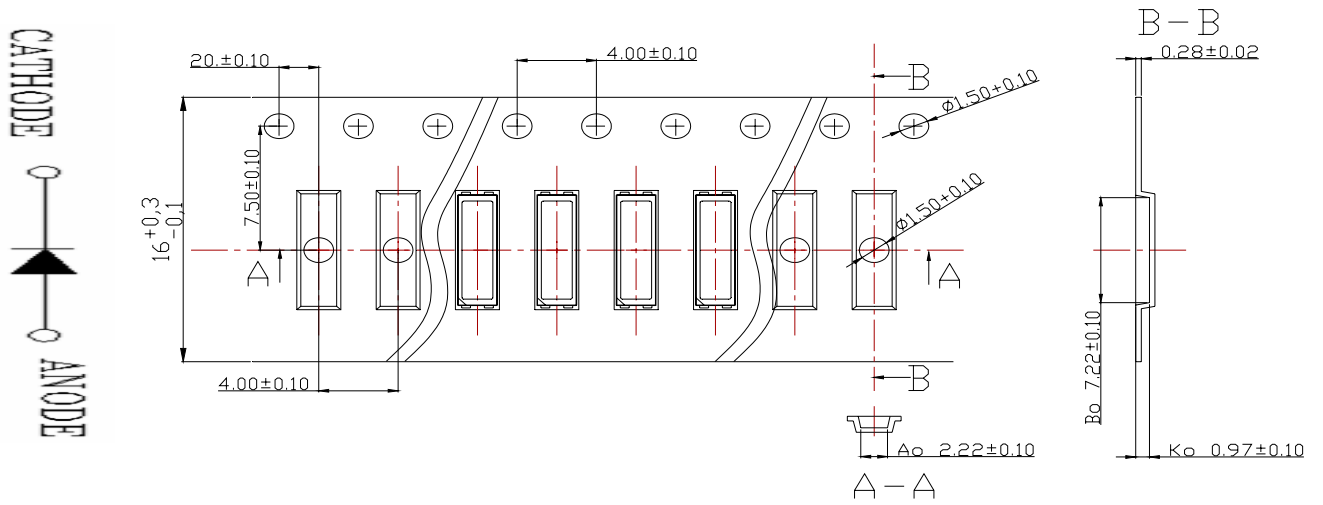
● Electrical and optical characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
*2Forward Voltage	V _F	I _F =150mA	2.9	-	3.4	V
Luminous Flux	Φ _v		50	55	-	lm
Chromaticity Coordinates	x		-	0.28	-	-
	y		-	0.26	-	-
Color Temperature	CCT		7040	-	30000	K
Viewing Angle	2θ _{1/2}		-	120	-	deg
Color Rendering Index	CRI		-	70	-	-

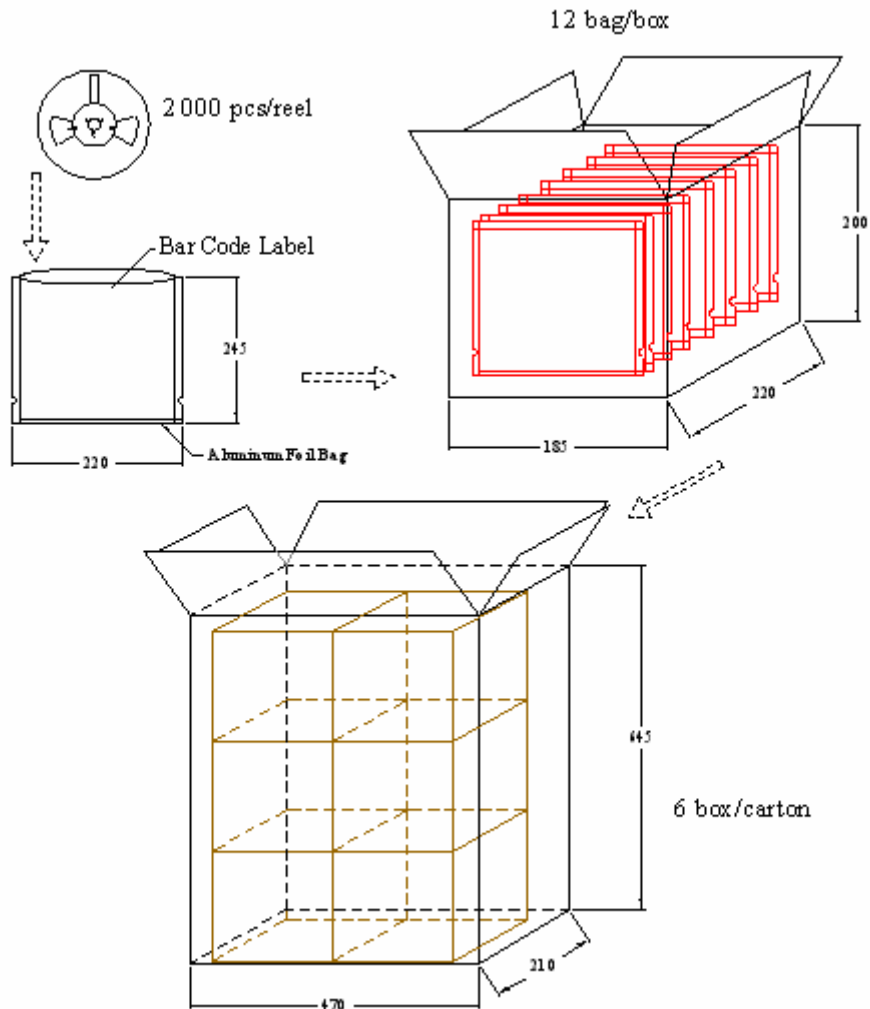
● Typical Electro-Optical Characteristics Curves.



● Tapping and packaging specifications(Units: mm)



● Package Method:(unit:mm)



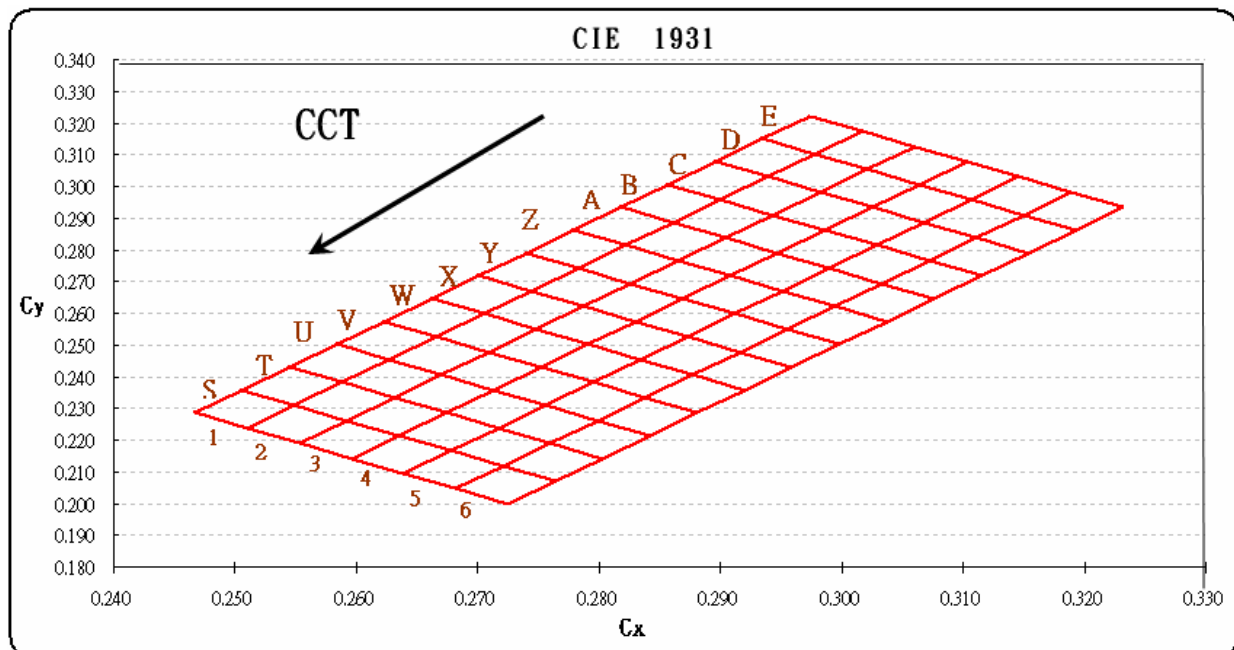
Bin of Luminous Flux (at 150mA)

BIN CODE	Min. (mcd)	Max. (mcd)	Min. (Lm)	Max. (Lm)
P	25000	27500	50	55
Q	27500	30000	55	60
R	30000	32500	60	65

Bin of Forward Voltage (at 150 mA,)

BIN CODE	Min. (v)	Max. (v)
Z	2.9	3.0
A	3.0	3.1
B	3.1	3.2
C	3.2	3.3
D	3.3	3.4

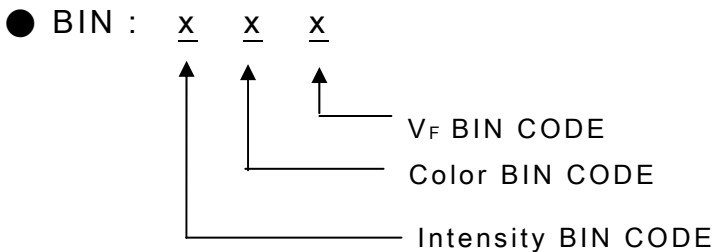
Chromaticity Diagram (at 150 mA)



Color Bin Limits (at 150mA)

S1		S2		S3		S4		S5		S6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2467	0.2286	0.251	0.2238	0.2553	0.219	0.2467	0.2286	0.251	0.2238	0.2553	0.219
0.2506	0.2358	0.2549	0.231	0.2592	0.2262	0.2506	0.2358	0.2549	0.231	0.2592	0.2262
0.2549	0.231	0.2592	0.2262	0.2635	0.2214	0.2549	0.231	0.2592	0.2262	0.2635	0.2214
0.251	0.2238	0.2553	0.219	0.2596	0.2142	0.251	0.2238	0.2553	0.219	0.2596	0.2142
T1		T2		T3		T4		T5		T6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2506	0.2358	0.2549	0.231	0.2592	0.2262	0.2506	0.2358	0.2549	0.231	0.2592	0.2262
0.2545	0.243	0.2588	0.2382	0.2631	0.2334	0.2545	0.243	0.2588	0.2382	0.2631	0.2334
0.2588	0.2382	0.2631	0.2334	0.2674	0.2286	0.2588	0.2382	0.2631	0.2334	0.2674	0.2286
0.2549	0.231	0.2592	0.2262	0.2635	0.2214	0.2549	0.231	0.2592	0.2262	0.2635	0.2214
U1		U2		U3		U4		U5		U6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2545	0.243	0.2588	0.2382	0.2631	0.2334	0.2674	0.2286	0.2717	0.2238	0.276	0.219
0.2584	0.2502	0.2627	0.2454	0.267	0.2406	0.2713	0.2358	0.2756	0.231	0.2799	0.2262
0.2627	0.2454	0.267	0.2406	0.2713	0.2358	0.2756	0.231	0.2799	0.2262	0.2842	0.2214
0.2588	0.2382	0.2631	0.2334	0.2674	0.2286	0.2717	0.2238	0.276	0.219	0.2803	0.2142
V1		V2		V3		V4		V5		V6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2584	0.2502	0.2627	0.2454	0.267	0.2406	0.2713	0.2358	0.2756	0.231	0.2799	0.2262
0.2623	0.2574	0.2666	0.2526	0.2709	0.2478	0.2752	0.243	0.2795	0.2382	0.2838	0.2334
0.2666	0.2526	0.2709	0.2478	0.2752	0.243	0.2795	0.2382	0.2838	0.2334	0.2881	0.2286
0.2627	0.2454	0.267	0.2406	0.2713	0.2358	0.2756	0.231	0.2799	0.2262	0.2842	0.2214
W1		W2		W3		W4		W5		W6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2623	0.2574	0.2666	0.2526	0.2709	0.2478	0.2752	0.243	0.2795	0.2382	0.2838	0.2334
0.2662	0.2646	0.2705	0.2598	0.2748	0.255	0.2791	0.2502	0.2834	0.2454	0.2877	0.2406
0.2705	0.2598	0.2748	0.255	0.2791	0.2502	0.2834	0.2454	0.2877	0.2406	0.292	0.2358
0.2666	0.2526	0.2709	0.2478	0.2752	0.243	0.2795	0.2382	0.2838	0.2334	0.2881	0.2286
X1		X2		X3		X4		X5		X6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2662	0.2646	0.2705	0.2598	0.2748	0.255	0.2791	0.2502	0.2834	0.2454	0.2877	0.2406
0.2701	0.2718	0.2744	0.267	0.2787	0.2622	0.283	0.2574	0.2873	0.2526	0.2916	0.2478
0.2744	0.267	0.2787	0.2622	0.283	0.2574	0.2873	0.2526	0.2916	0.2478	0.2959	0.243
0.2705	0.2598	0.2748	0.255	0.2791	0.2502	0.2834	0.2454	0.2877	0.2406	0.292	0.2358
Y1		Y2		Y3		Y4		Y5		Y6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2701	0.2718	0.2744	0.267	0.2787	0.2622	0.283	0.2574	0.2873	0.2526	0.2916	0.2478
0.274	0.279	0.2783	0.2742	0.2826	0.2694	0.2869	0.2646	0.2912	0.2598	0.2955	0.255
0.2783	0.2742	0.2826	0.2694	0.2869	0.2646	0.2912	0.2598	0.2955	0.255	0.2998	0.2502
0.2744	0.267	0.2787	0.2622	0.283	0.2574	0.2873	0.2526	0.2916	0.2478	0.2959	0.243
Z1		Z2		Z3		Z4		Z5		Z6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.274	0.279	0.2783	0.2742	0.2826	0.2694	0.2869	0.2646	0.2912	0.2598	0.2955	0.255
0.2779	0.2862	0.2822	0.2814	0.2865	0.2766	0.2908	0.2718	0.2951	0.267	0.2994	0.2622
0.2822	0.2814	0.2865	0.2766	0.2908	0.2718	0.2951	0.267	0.2994	0.2622	0.3037	0.2574
0.2783	0.2742	0.2826	0.2694	0.2869	0.2646	0.2912	0.2598	0.2955	0.255	0.2998	0.2502

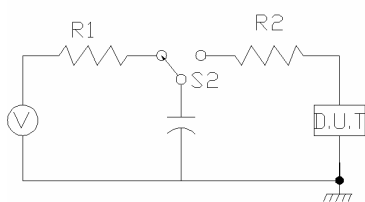
A1		A2		A3		A4		A5		A6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2779	0.2862	0.2822	0.2814	0.2865	0.2766	0.2908	0.2718	0.2951	0.267	0.2994	0.2622
0.2818	0.2934	0.2861	0.2886	0.2904	0.2838	0.2947	0.279	0.299	0.2742	0.3033	0.2694
0.2861	0.2886	0.2904	0.2838	0.2947	0.279	0.299	0.2742	0.3033	0.2694	0.3076	0.2646
0.2822	0.2814	0.2865	0.2766	0.2908	0.2718	0.2951	0.267	0.2994	0.2622	0.3037	0.2574
B1		B2		B3		B4		B5		B6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2818	0.2934	0.2861	0.2886	0.2904	0.2838	0.2947	0.279	0.299	0.2742	0.3033	0.2694
0.2857	0.3006	0.29	0.2958	0.2943	0.291	0.2986	0.2862	0.3029	0.2814	0.3072	0.2766
0.29	0.2958	0.2943	0.291	0.2986	0.2862	0.3029	0.2814	0.3072	0.2766	0.3115	0.2718
0.2861	0.2886	0.2904	0.2838	0.2947	0.279	0.299	0.2742	0.3033	0.2694	0.3076	0.2646
C1		C2		C3		C4		C5		C6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2857	0.3006	0.29	0.2958	0.2943	0.291	0.2986	0.2862	0.3029	0.2814	0.3072	0.2766
0.2896	0.3078	0.2939	0.303	0.2982	0.2982	0.3025	0.2934	0.3068	0.2886	0.3111	0.2838
0.2939	0.303	0.2982	0.2982	0.3025	0.2934	0.3068	0.2886	0.3111	0.2838	0.3154	0.279
0.29	0.2958	0.2943	0.291	0.2986	0.2862	0.3029	0.2814	0.3072	0.2766	0.3115	0.2718
D1		D2		D3		D4		D5		D6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2896	0.3078	0.2939	0.303	0.2982	0.2982	0.3025	0.2934	0.3068	0.2886	0.3111	0.2838
0.2935	0.315	0.2978	0.3102	0.3021	0.3054	0.3064	0.3006	0.3107	0.2958	0.315	0.291
0.2978	0.3102	0.3021	0.3054	0.3064	0.3006	0.3107	0.2958	0.315	0.291	0.3193	0.2862
0.2939	0.303	0.2982	0.3025	0.3068	0.2886	0.2939	0.303	0.2982	0.3025	0.3068	0.2886
E1		E2		E3		E4		E5		E6	
Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy	Cx	Cy
0.2935	0.315	0.2978	0.3102	0.3021	0.3054	0.3064	0.3006	0.3107	0.2958	0.315	0.291
0.2974	0.3222	0.3017	0.3174	0.306	0.3126	0.3103	0.3078	0.3146	0.303	0.3189	0.2982
0.3017	0.3174	0.306	0.3126	0.3103	0.3078	0.3146	0.303	0.3189	0.2982	0.3232	0.2934
0.2978	0.3102	0.3021	0.3054	0.3064	0.3006	0.3107	0.2958	0.315	0.291	0.3193	0.2862



Notes:

1. I_v : Tolerance for each Bin limit is ± 10 %
2. Color : Tolerance for each Bin limit is ±0.005
3. Bin categories are established for classification of products.
Products may not be available in all bin categories

● Reliability Test

Test Item	Test Conditions	Test Hours/ Cycles	Result
Steady State Operating Life of High Temperature	$I_F=150\text{mA}$ $T_a=60^\circ\text{C}$	1,000hrs	0/20
Steady State Operating Life	$I_F=150\text{mA}$ $T_a=25^\circ\text{C}$	3,000hrs	0/20
Steady State Operating Life Low Temperature Condition1	$I_F=150\text{mA}$ $T_a=-30^\circ\text{C}$	1,000hrs	0/20
Steady State Operating Life Of High Humidity Heat	$I_F=150\text{mA}$ $T_a=60^\circ\text{C}$ RH=75%	1,000hrs	0/20
Thermal shock	$-45^\circ\text{C} \sim +125^\circ\text{C}$ 30 min 30 min	100cycle	0/20
Temperature & Humidity Cycling	$T_a=25^\circ\text{C} \sim +65^\circ\text{C} \sim -10^\circ\text{C}$ RH=90%RH,24hr/1cycle	1cycle	0/20
Resistance to Soldering Heat	$T_{\text{sold}}=260^\circ\text{C}$,10sec(Pre treatment 30°C ,70%,168hrs)	2times	0/20
ESD(HBM)	 <p>-R1:10 KΩ,R2:1.5 KΩ,C:100 pF Discharge Time:3 times</p>	Min.2KV	0/5

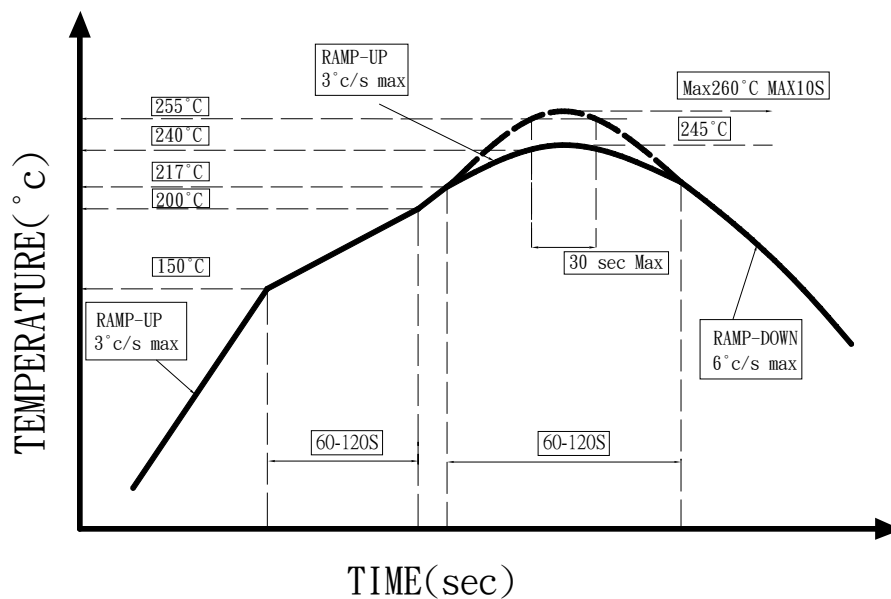
● Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V_F (V)	$I_F=150\text{mA}$	Over $U^1 \times 1.2$
Reverse current	I_R (μA)	$V_R=5\text{V}$	Over $U^1 \times 2$
Luminous intensity	I_v (mcd)	$I_F=150\text{mA}$	Below $S^1 \times 0.5$

Note: 1. U means the upper limit of specified characteristics. S means initial value.

2. After each test, remove test pieces, wait for 2 hours and test pieces have returned to ambient temperature, then take next measurement.

● IR-Reflow Soldering



1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering .
2. Avoid rapid cooling or any excess vibration during temperature ramp-down process
3. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

● IRON Soldering

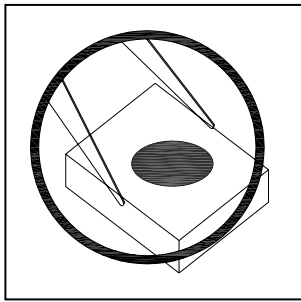
300°C Within 3 sec, one time only.

Handling Precautions

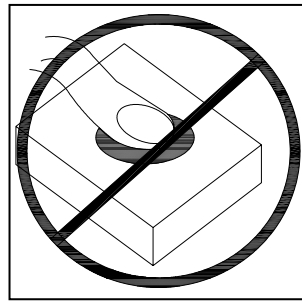
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

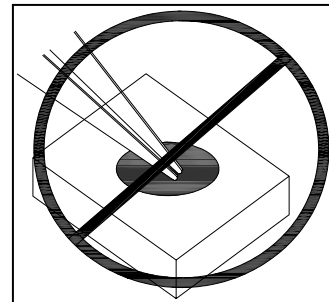
1. Handle the component along the side surfaces by using forceps or appropriate tools. (pic.1)
2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry. (pic.2,pic.3)
3. Do not stack together assembled PCBs, containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry. (pic.4)
4. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible. (pic.5)
5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup. (pic.5)
6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production. (pic.5)



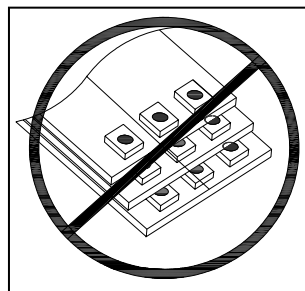
Pic.1



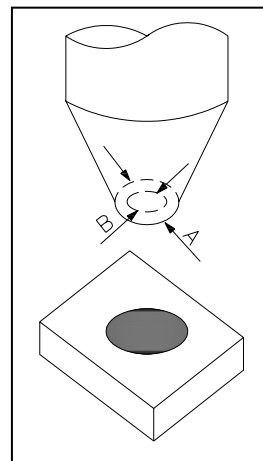
Pic.2



Pic.3



Pic.4



Pic.5

● **Notes for designing:**

Care must be taken to provide the current limiting resistor in the circuit so as to drive the LEDs within the rated figures. Also, caution should be taken not to overload LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as to be subjected to reverse voltage when turning off the LEDs.

● **Storage:**

In order to avoid the absorption of moisture, it is recommended to solder LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5°C-30°C(41°F) Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
 - a. Completed within 168 hours.
 - b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if:
 - 2a or 2b is not met.
- (4) If baking is required, devices must be baked under below conditions:
 - 48 hours at 60°C±3°C.

● **Package and Label of Products:**

- (1) Package: Products are packed in one bag of 1000 pcs (one taping reel) and a label is attached to each bag.
- (2) Label:

